



# ICPT 2019

## International Conference on Planarization/CMP Technology 2019

Ambassador Hotel, Hsinchu, Taiwan

September 15 (SUN) – September 18 (WED), 2019

Conference website: <http://www.icpt2019.org>

### Tutorial, Conference, Exhibition & Tour

- Sep. 15: Tutorial
- Sep. 16-18: Conference & Exhibition
- Sep. 18: Tour  
(TSMC Museum of Innovation;  
Technology Star Exhibition Hall, ITRI)

### Important date

- Abstract Submission Deadline:  
~~April 30, 2019~~ **May 15, 2019**
- Author Notification:  
**June 30, 2019**
- Final Extended Abstract Submission:  
**July 31, 2019**

### Topics

1. FEOL CMP
2. BEOL CMP
3. Defects, reliability issues and Post CMP cleaning
4. CMP fundamentals, modeling and simulation
5. Equipment and metrology
6. Process control
7. Emerging technologies in CMP
8. CMP consumables
9. 3D ICs/TSV applications
10. Alternative CMP technologies
11. CMP for MEMS
12. Hybrid IC

### Conference fee

Rate	Early bird (Before & on July 5)	Regular (After July 5)
Full	US \$600	US \$700
Student	US \$350	US \$400

### Tutorial fee\*

\*Only for ICPT conference registration member

Rate	Early bird (Before & on July 5)	Regular (After July 5)
Full	US \$200	US \$300
Student	US \$100	US \$150

### Organized by

